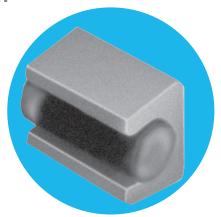
Resistors



Metal Glaze™ Power Pack Surface Mount High **Power Density Ceramic Package**

PPS-1 Series

- Low inductance
- 0.1Ω to 348KΩ range
- Superior surge handling capability
- 150°C maximum operating temperature
- 1 Watt performance standard 2010 footprint
- Flameproof ceramic package provides superior temperature rise profile



NOT RECOMMENDED FOR NEW DESIGNS

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All Pb-free parts comply with EU Directive 2011/65/EU (RoHS2)

Flectrical Data

Size	Туре	Maximum Power Rating	Working Voltage¹	Maximum Voltage	Resistance Range (ohms)	Tolerance (±%)²	TCR (ppm/°C)²
2010	DDC 1	PS-1 1W 350 700	700	0.1 to 0.99	1, 2, 5	100	
2010	PP3-1		350	700	1.0 to 348K	1, 2, 5	50, 100
Not to exceed (\(\subseteq \text{PYR} \) 2 Consult factory for tighter tolerances and TCRs							

Applications

The PPS-1 will dissipate 1 watt at 70°C on a 2010 footprint. The PPS-1 is recommended for applications where board real estate or component/board TCE mismatch is a major concern. It is also recommended in circuits where a standard 2010 resistor exhibits marginal or unacceptable performance due to high power density/surge handling demands.

Environmental Data

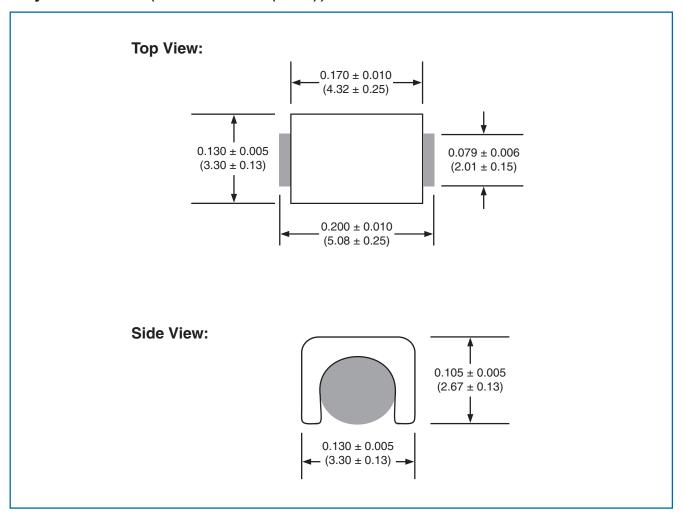
Characteristic	Maximum Change	Test Method	
Thermal Shock	±(0.5% + 0.01 ohm)	MIL-R-55342E Par 4.7.3 (-65°C + 150°C, 5 cycles)	
Low Temperature Operation	±(0.25% + 0.01 ohm)	MIL-R-55342E Par 4.7.4 (-65°C @ working voltage)	
Short Time Overload	±(1.0% + 0.01 ohm)	MIL-R-55342E Par 4.7.5 (2.5 x (PxR) ^{1/2}	
High Temperature Exposure	±(0.5% + 0.01 ohm)	MIL-R-55342E Par 4.7.6 (+150°C for 100 hours)	
Resistance to Bonding Exposure	±(0.25% + 0.01 ohm)	MIL-R-55342E Par 4.7.7 (Reflow soldered to board @ 26 for 10 seconds)	
Solderability	95% minimum coverage	MIL-STD-202, Method 208 (245°C for 5 seconds)	
Moisture Resistance	±(0.5% + 0.01 ohm)	MIL-R-55342E Par 4.7.8 (10 cycles, total 240 hours)	
Life Test	±(1.0% + 0.01 ohm)	MIL-R-55342E Par 4.7.10 (2000 hours @ 70°C intermittent)	
Terminal Adhesion Strength	±(1% + 0.01 ohm)	1200 gram push from underside of mounted chip for 60 seconds	
Resistance to Board Bending	±(1% + 0.01 ohm)	Chip mounted in center of 90mm long board, deflected 5mm so as to exert pull on chip contacts for 10 seconds	



PPS-1 Series

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Physical Data (Inches and (mm))





PPS-1 Series

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Ordering Procedure

This product has two valid part numbers:

European (Welwyn) Part Number: PPS1-100RFI (PPS1 with TCR ±100ppm/°C at 100 ohms ±1%, Pb-free)



1	2	3	4	5
Type	TCR (ppm/°C)	Value	Tolerance	Termination & Packing
PPS1	Omit for ±100	E24 = 3/4 characters	F = ±1%	I = Pb-free, Tape Pack
	-50 = ±50	E96 = 4/5 characters	G = ±2%	PB = SnPb, Tape Pack
		R = ohms	J = ±5%	500/reel
		K = kilohms		

USA (IRC) Part Number: PPS11001000FLF (PPS1 with TCR ±100ppm/°C at 100 ohms ±1%, Pb-free)

PPS1	1 0 0	1 0 0 0	F L F
1	2	3	4 5

1	2	3	4	5	
Type TCR		Value	Tolerance	Termination & Packing	
PPS1	$50 = \pm 50$	3 digits + multiplier	F = ±1%	Omit for SnPb	
	$100 = \pm 100$	R = ohms for	G = ±2%	LF = Pb-free	
		values <100 ohms	J = ±5%	500/reel	